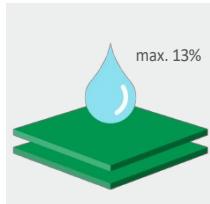


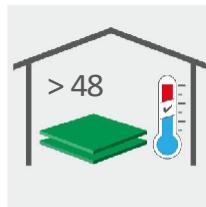
Important information on laying esb & chipboard

Installation boards for use in floors and walls, non-load-bearing or load-bearing in accordance with DIN EN 312:2010

Transport and storage

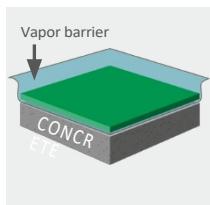


The moisture content of the boards is approx. 9% ex works. During transport and storage, the wood moisture content must not exceed 13%. Ensure that the boards are stored **flat** and **horizontal** on a dry surface.

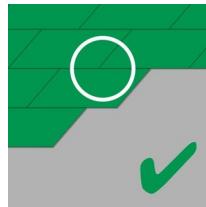


Before installation, the panels must be stored in the installation room for several days to allow them to acclimatize. Installation should be carried out under normal climatic conditions, i.e. not in overheated, unventilated, cold, or damp rooms.

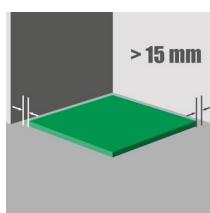
Installation instructions



When laying on **ceilings and walls**, check that a **vapor barrier** suitable for the property is used to protect against moisture and install it if necessary.



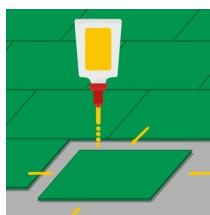
As a general rule, the tiles should be **laid in a pattern**; **cross joints** must not occur.



A **border clearance** of 2-3 mm per meter of length and width of the area to be laid must be maintained, **with a minimum of 15 mm**.



Sand the tile joints flush, fill any joints and sand again.



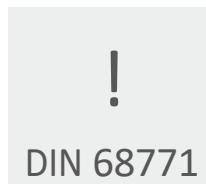
Carefully spread the **adhesive** around the boards, applying it to both sides of the tongue if possible.



Once laid, the panels should be **covered** immediately with the intended covering or **with a PE film** to prevent moisture and damage.



The panels must be **protected** from moisture during use, e.g. from cleaning water or condensation.



DIN 68771 "Wood chipboard subfloors" must be observed. Obvious or recognizable technical/quality defects must be reported to your contractual partner immediately after they become known. Complaints after processing/assembly cannot be accepted.